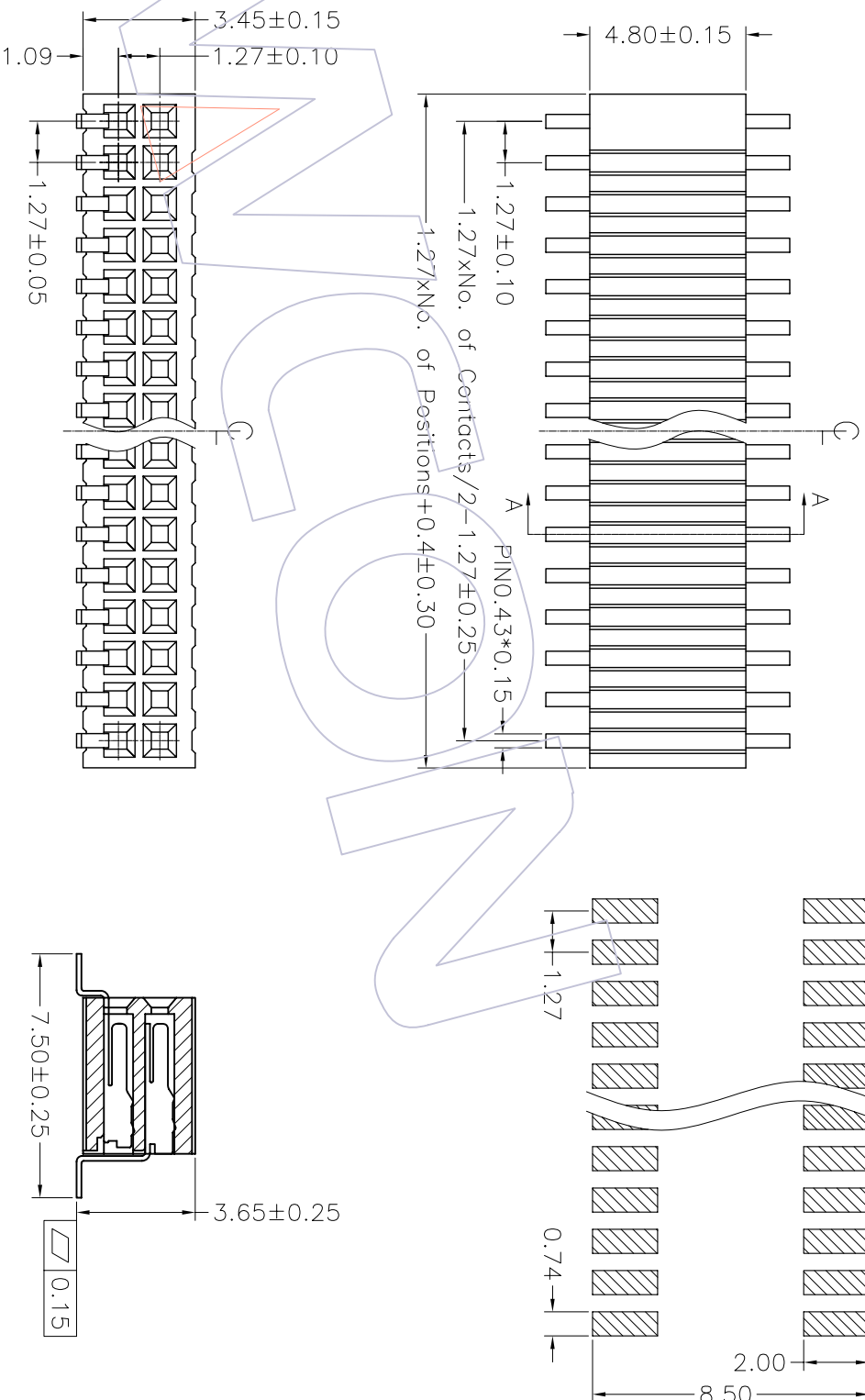


# HSP

Recommended P.C.B Layout(Top Side)  
(PCB BOARD TOLERANCE±0.05)

**NOTES:**

- Current Rating: 1.0AMP
- Withstand Voltage: 500V AC/DC
- Contact Resistance: 20mΩ Max
- Insulation Resistance: 1000MΩMin
- Operation Temperature: -40°C to +105°C
- Contact Material: Phosphor Bronze
- Contact plating: Au or Sn over Ni
- Insulator Material: PA6T+30%G. F UL94V-0



## Ordering Information

2335 - 2 XX M XX CUNT 1

- No.of Pins per ROW:02-50PIN
- Contact Plating: G0=Gold Flash
- G1=5μr"Gold
- G2=5μr"Gold
- G3=10μr"Gold
- G4=15μr"Gold
- G5=30μr"Gold
- S0=Gold Flash/Tin
- S1=5μr"Gold/Tin
- S2=5μr"Gold/Tin
- S3=10μr"Gold/Tin
- S4=15μr"Gold/Tin
- S5=30μr"Gold/Tin
- SN=Tin

- Packaging: T=Tube
- R=Tap&Reel/CAP
- P=Tube/CAP

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	SCALE	PART NO.	TITLE:
A0	08/02/16	NEW			X.XX ±0.40 X.XX ±0.25 X.XXX ±0.15 Angle ± 3°	DESIGN CHECK	5:1 mm A4	2335-2XXMXXCUNT1	FH1.27mm DUAL SIDE INSERT SMT H=3.45
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	DIM	TOL	APPROVE	PROJ.	Customer NO.

**WCON** 维峰五金电子有限公司  
WAPE HARDWARE ELECTRONICS CO. LTD